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**Patent**

**MAY 11 2006**

Customer No.: 31561  
Docket No.: 11530-US-PA  
Application No.: 10/709,954

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Applicant : Ho et al.

Application No. : 10/709,954

Filed : June 9, 2004

For : ELECTRICAL PACKAGE CAPABLE OF INCREASING  
THE DENSITY OF BONDING PADS AND FINE CIRCUIT  
LINES INSIDE A INTERCONNECTION

Art Unit : 2826

Examiner : WILLIAMS, ALEXANDER O.

**TRANSMITTAL LETTER**

+1-571-273-2885 (Via fax: 1+2 pages)

Assistant Commissioner for Patents  
Alexandria, VA 22314

Dear Sir,

In response to the Notice of Allowance and Fee(s) due, dated March 27, 2006,

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